

## Continental Device India Limited

An IS/ISO 9002 and IECQ Certified Manufacturer



## **SILICON PLANAR EPITAXIAL TRANSISTORS**



BC 307, A, B, C BC 308, A, B, C BC 309, A, B, C

TO-92

**Plastic Package** 

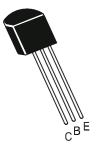
# **General Purpose Transistors Deisgned For Small Signal Amplification**

### From DC To Low Radio Frequencies

#### ABSOLUTE MAXIMUM RATINGS (Ta=25°C unless specified otherwise)

DESCRIPTION	SYMBOL	BC307	BC308	BC309	UNITS
Collector Emitter Voltage	$V_{CEO}$	45	25	25	V
Collector Base Voltage	$V_{CBO}$	50	30	30	V
Emitter Base Voltage	$V_{EBO}$	5	5	5	V
Collector Current Continuous	$I_{C}$		100		mA
Power Dissipation@ Ta=25°C	$P_{D}$		350		mW
Derate Above 25°C			2.8		mW/°C
Power Dissipation@ Tc=25°C	$P_{D}$		1		W
Derate Above 25°C			8		mW/°C
Operating And Storage Junction	$T_{j},T_{stg}$	-:	55 to +15	50	°C
Temperature Range					
THERMAL RESISTANCE					
Junction to ambient	$R_{th(j-a)}$		357		°C/W
Junction to case	R <sub>th(j-c)</sub>		125		°C/W

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ELECTRICAL CHARACTERISTICS (Ta=25°C unless specified otherwise)								
DESCRIPTION	SYMBOL	TEST CONDITION	MIN	TYP	MAX	UNITS		
Collector Emitter Breakdown	$BV_CEO$	$I_C=2mA,I_B=0$						
Voltage								
BC307			45			V		
BC308, BC309			25			V		
Emitter Base Breakdown Voltage	$BV_EBO$	I <sub>E</sub> =100uA, I <sub>C</sub> =0	5			V		
Collector Emitter Leakage Current								
BC307	$I_{CES}$	$V_{CES} = 50V$ , $V_{BE} = 0$			15	nA		
BC308, BC309		$V_{CES} = 30V, V_{BE} = 0$			15	nA		
BC307		$V_{CES} = 50V$ , $V_{BE} = 0$ ,			4	μΑ		
		T <sub>A</sub> =125°C				•		
BC308, BC309		$V_{CES} = 30V$ , $V_{BE} = 0$ ,			4	μΑ		
		$T_A = 125^{\circ}C$				·		
DC Current Gain		^						
Α	$h_{FE}$	$I_C=10uA, V_{CE}=5V$		90				
В				150				
С				270				
BC307, BC308, BC309		$I_C=2mA, V_{CE}=5V$	120		800			
Α			120	170	220			
В			200	290	460			
С			420	500	800			
А		$I_C=2mA, V_{CE}=5V^*$		120				
В		0 / 02		180				
С				300				
Collector Emitter Saturation	V <sub>CE</sub> (sat)	$I_C=10mA, I_B=0.5mA$		0.10	0.3	V		
Voltage	0_1, /	$I_C=100\text{mA}, I_B=5\text{mA}$		0.25		V		
Base Emitter Saturation Voltage	V <sub>BE</sub> (sat)	$I_C=10\text{mA}, I_B=0.5\text{mA}$		0.7		V		
· ·	,	$I_C=100$ mA, $I_B=5$ mA		1.0		V		
Base Emitter On Voltage	$V_{BE}(on)$	$I_C=2mA, V_{CE}=5V$	0.55	0.62	0.7	V		

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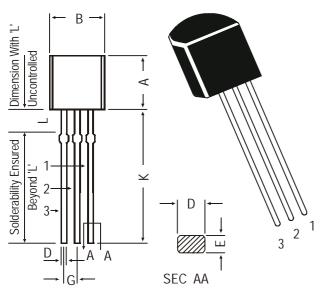
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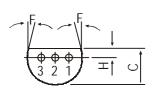
ELECTRICAL CHARACTERISTICS (Ta=25°C unless specified otherwise)

DESCRIPTION	SYMBOL	TEST CONDITION	MIN	TYP	MAX	UNITS
DYNAMIC CHARACTERISTICS						
Transition Frequency	$f_T$	I <sub>C</sub> =10mA, V <sub>CE</sub> =5V				
BC307	7	f=50MHz		280		MHz
BC308	3			320		MHz
BC309	)			360		MHz
Collector Base Capacitance	$C_cbo$	V <sub>CB</sub> =10V, I <sub>E</sub> =0			6	pF
Noise Figure		f=1MHz				
BC 309	) NF	$I_C$ =0.2mA, $V_{CE}$ =5V Rg=2K $\Omega$ f=30Hz to 15KHz		2	4	dB
BC307, BC308	3	f =1KHz, B=200Hz		2	10	dB
BC309	)			2	4	dB
		$R_S$ =2 $K\Omega$ f=30 $Hz$				
		to 15KHz				

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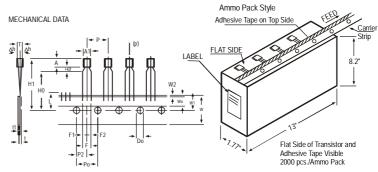
#### PIN CONFIGURATION

- 1. EMITTER
- 2. BASE
- 3. COLLECTOR

DIM	MIN.	MAX.			
А	4.32	5.33			
В	4.45	5.20			
С	3.18	4.19			
D	0.41	0.55			
Е	0.35	0.50			
F	5 D	EG			
G	1.14	1.40			
Н	1.14	1.53			
K	12.70	_			
L	1.982	2.082			

All diminsions in mm.

#### **TO-92 Transistors on Tape and Ammo Pack**



#### All dimensions in mm unless specified otherwise

ITEM		SPECIFICATION				551115116	
ITEM	SYMBOL	MIN. NOM. MAX. TOL		TOL .	REMARKS		
BODY WIDTH	A1	4.0		4.8			
BODY HEIGHT	Α	4.8		5.2			
BODY THICKNESS	Ţ	3.9		4.2			
PITCH OF COMPONENT	Р		12.7		±1		
FEED HOLE PITCH	Po		12.7		±0.3	CUMULATIVE PITCH ERROR 1.0 mm/20 PITCH	
FEED HOLE CENTRE TO	D0		/ 25				
COMPONENT CENTRE	P2		6.35		±0.4	TO BE MEASURED AT BOTTOM OF CLINCH	
DISTANCE BETWEEN OUTER	_				+0.6		
LEADS	F		5.08		-0.2	47 TOD OF DODY	
COMPONENT ALIGNMENT	Δh		0 18	1	۸.	AT TOP OF BODY	
TAPE WIDTH HOLD-DOWN TAPE WIDTH	W Wo		18 6		±0.5 +0.2		
HOLE POSITION	W1		9		±0.2 +0.7		
HOLE POSITION	VVI		9		-0.5		
HOLD-DOWN TAPE POSITION	W2		0.5		±0.2		
LEAD WIRE CLINCH HEIGHT	Но		16		±0.5		
COMPONENT HEIGHT	H1			23.25			
LENGTH OF SNIPPED LEADS	L			11.0			
FEED HOLE DIAMETER	Do		4	١	±0.2		
TOTAL TAPE THICKNESS	t		2.54	1.2	١.,	t1 0.3 - 0.6	
LEAD - TO - LEAD DISTANCEF1,	F2		2.54		+0.4 -0.1		
CLINCH HEIGHT	H2			3			
PULL - OUT FORCE	(P)	6N					

- NOTES
  1. MAXIMUM ALIGNMENT DEVIATION BETWEEN LEADS NOT TO BE GREATER THAN 0.2 mm.
- MAXIMUM NON-CUMULATIVE VARIATION BETWEEN TAPE FEED HOLES SHALL NOT EXCEED 1 mm IN 20 PITCHES.

   HOLDDOWN TAPE NOT TO EXCEED BEYOND THE EDGE(S) OF CARRIER TAPE AND THERE SHALL BE NO EXPOSURE OF ADHESIVE.

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- A. NO MORE THAN 3 CONSECUTIVE MISSING COMPONENTS ARE PERMITTED.
   A TAPE TRAILER, HAVING AT LEAST THREE FEED HOLES ARE REQUIRED AFTER THE LAST COMPONENT.
   SPLICES SHALL NOT INTERFERE WITH THE SPROCKET FEED HOLES.

# Packing Detail

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PACKAGE	STANDARD PACK		INNER CARTO	N BOX	OUTER CARTON BOX					
	Details	Net Weight/Qty	Size	Qty	Size	Qty	Gr Wt			
TO-92 Bulk	1K/polybag	200 gm/1K pcs	3" x 7.5" x 7.5"	5K	17" x 15" x 13.5"	80K	23 kgs			
TO-92 T&A	2K/ammo box	645 gm/2K pcs	12.5" x 8" x 1.8"	2K	17" x 15" x 13.5"	32K	12.5 kgs			

**Notes** 

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#### **Disclaimer**

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